

UG10241_ZH

MCUXpresso 安全配置快速入门指南

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User guide

Document information

Information	Content
Keywords	MCUXpresso 安全配置工具
Abstract	MCUXpresso Secure Provisioning Tool (SEC, MCUXpresso 安全配置工具) 是一个旨在简化NXP MCU 平台上可启动的可执行文件的生成和配置过程的 GUI 工具。它建立在由 NXP 提供的、经验证的且成熟稳定的安全特性布署工具集之上，并利用了 BootROM 提供的丰富的编程接口。



1 MCUXpresso 安全配置工具快速入门指南

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2 概述

本快速入门指南提供了分步概述，帮助您高效地安装、配置和开始使用 MCUXpresso 安全配置工具。无论您是安全启动和加密工作流程的新手，还是希望将安全配置集成到您的生产流程中，本指南都将帮助您快速入门。

MCUXpresso 安全配置工具（SEC 工具）是 NXP 开发的一款功能强大的实用程序，用于简化嵌入式设备的安全配置。该工具旨在支持各种 NXP 微控制器，使开发人员能够配置安全功能、生成加密密钥并以最少的设置安全地编程设备。

3 硬件要求

- 建议从 NXP 的参考设计板（FRDM/EVK）开始。
- [Secure Provisioning Tool Release Notes](#)列出了启动安全配置工具的详细要求。

4 软件要求

MCUXpresso 安全配置工具可以在 Windows、Linux 或 mac 操作系统上执行。[Secure Provisioning Tool Release Notes](#)列出了详细要求。

5 安装并配置 SEC 工具

安全配置工具安装程序适用于 Windows、Linux 或 mac 操作系统，可从 [NXP Secure Provisioning web](#) 下载。对于 Windows 和 mac，安装程序以向导的形式引导您逐步完成安装过程。Debian 软件包可用于 Linux。有关安装的详细信息，请参阅[Secure Provisioning Tool User Guide](#)。

6 使用工具

6.1 前提条件

作为该工具的输入，使用在处理器上运行的应用程序二进制文件（S19、HEX、ELF/AXF 或 BIN 文件格式）。根据启动设备，为 RAM 或 Flash 构建应用程序。建议从任何 MCUXpresso SDK 示例开始，该示例已预先配置了正确的地址。在使用安全配置工具之前，请在调试器中运行应用程序并检查它是否按预期工作。

对于 FRDM 和 EVK 板，提供了二进制形式的示例应用程序，通常会使板载 LED 闪烁。即使您还没有任何特定的应用程序，它也可以用于评估工具功能。

要将应用程序加载到开发板中，请将开发板切换到 In-System-Programming (ISP) 模式。有关如何执行此操作的详细信息，请查阅开发板文档或处理器参考手册。

6.2 新工作区

当您第一次启动安全配置工具时，它会要求您创建一个新的工作区，该文件夹包含项目所需的所有文件。您也可以稍后使用命令创建新的工作区：**main menu > File > New Workspace**。

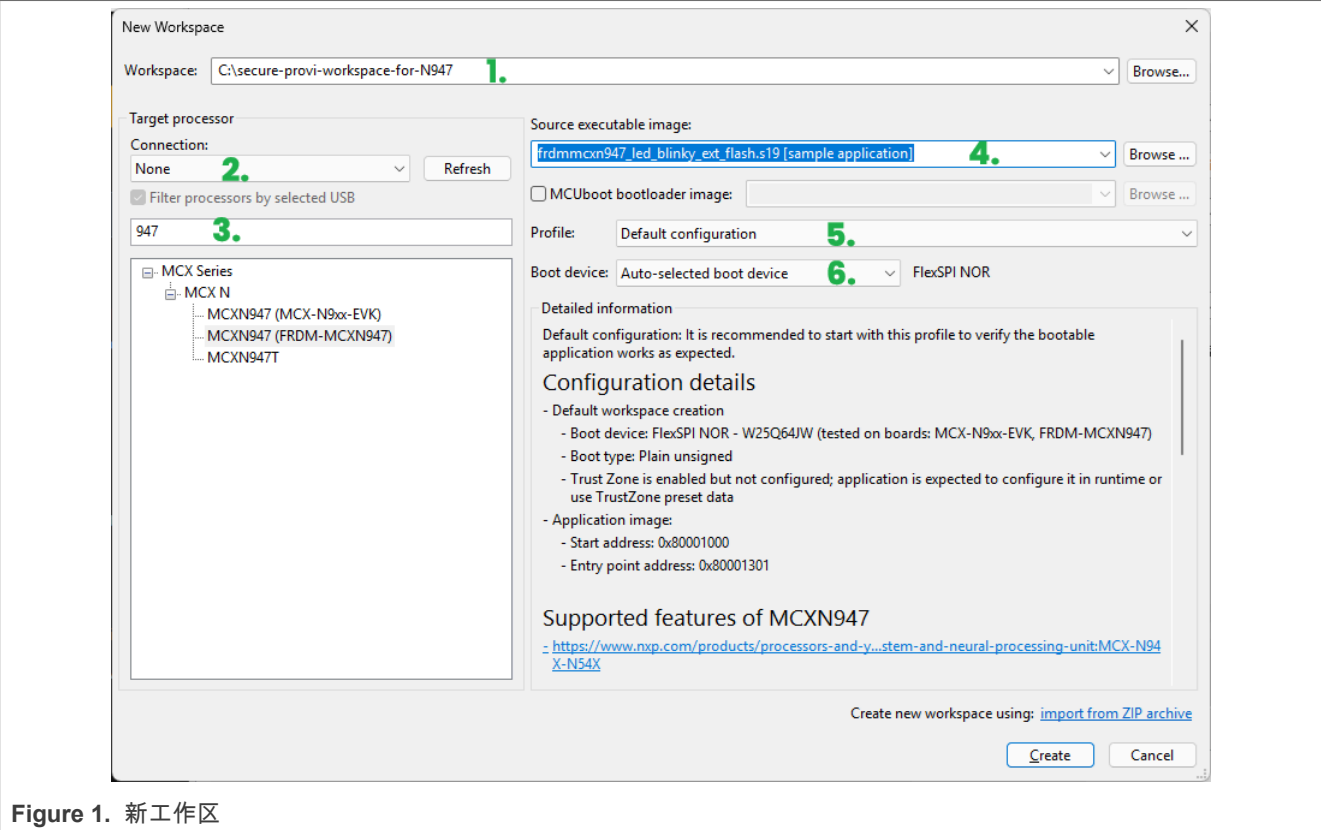


Figure 1. 新工作区

要创建工作区，请填写以下参数：

1. 选择磁盘上的工作区路径。建议为每个项目创建一个新文件夹。
2. 将设备连接到您的计算机并选择使用的连接，例如 UART 端口或 USB。使用 USB 连接，该工具可以自动选择处理器系列。其他连接类型可稍后在工具中选择。
3. 可以直接从树中选择处理器或使用搜索栏。也可以使用开发板名称来查找处理器。
4. 选择应用程序的路径作为源可执行镜像（image）。
注意 1：对于 NXP 开发板，该工具包含可从下拉列表中选择预编译 SDK 示例。注意 2：如果可能，请不要使用二进制（*.bin）文件格式，因为它不包含镜像地址的信息。
5. 要验证应用程序的构建和写入过程，请使用应用程序代码未签名且纯文本（未加密）的 Default 配置文件。稍后，当您已经在工具中测试了应用程序时，您可以选择一个安全配置文件，并且该工具会生成密钥并预生成安全启动的配置。
6. 选择启动设备类型。可以使用 Auto-selected boot device，工具会根据镜像地址检测启动设备。
7. 单击 **Create** 按钮来创建工作区。

6.3 工具图形用户界面

创建工作区后，将显示工具主窗口。主窗口包含：

1. 主菜单
2. 工具栏
3. “Build image”、“Write image”和“PKI management”选项卡
4. 日志视图
5. 状态行

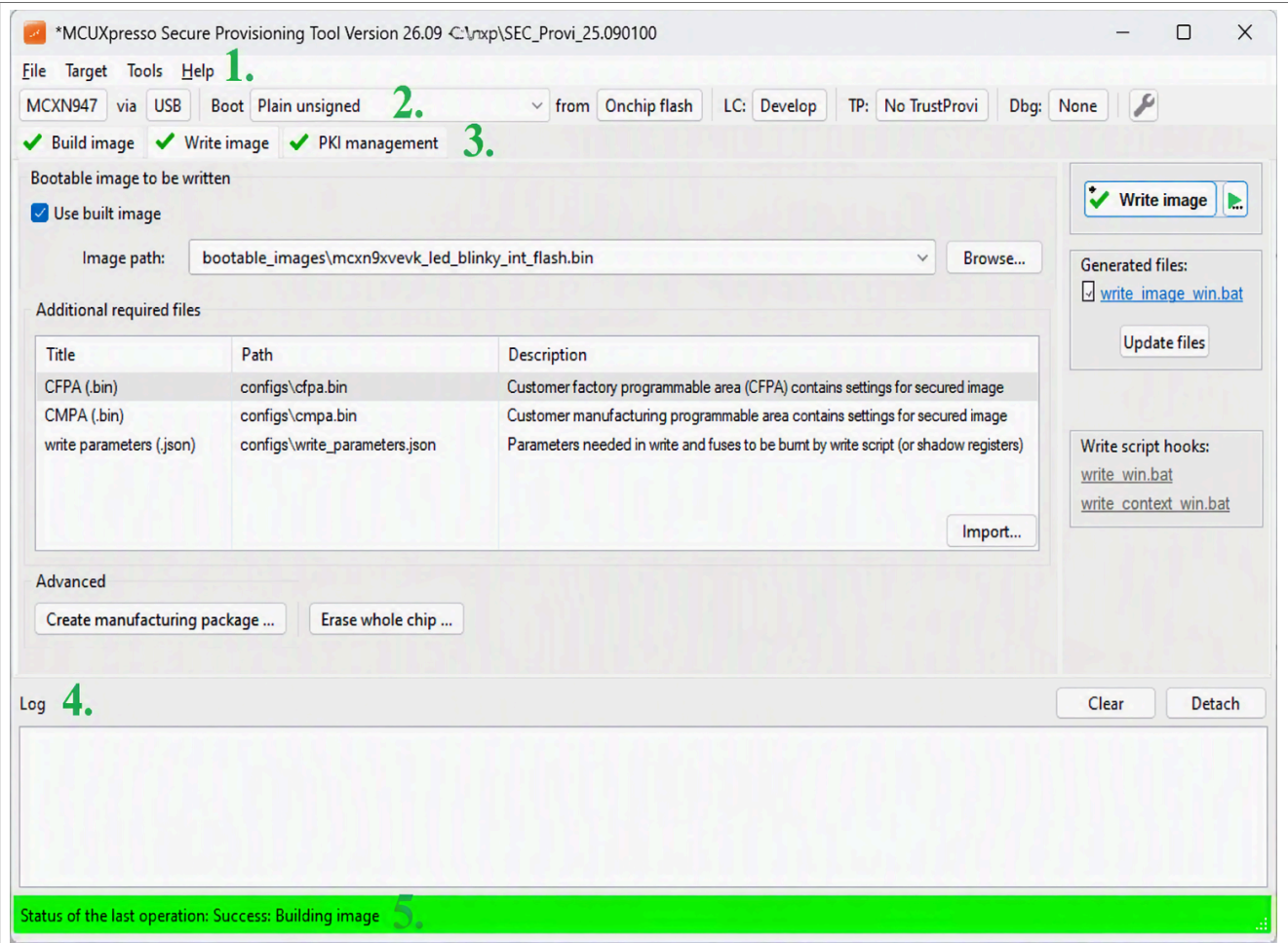


Figure 2. 工具图形用户界面

第一步，仔细检查工具栏上的配置是否符合您的要求。您将在那里找到：

1. 选定的处理器（已在向导中选择）
2. 与处理器的连接（已在向导中选择）
3. 启动模式（已在向导中选择）
4. 启动内存（内存类型可在向导中选择）
5. 生命周期（建议从默认值开始）
6. 信任配置（建议从默认值开始）
7. 调试探针（对于大多数处理器来说，您不需要这个；它可用于设置代替 fuse 的影子寄存器，或用于为没有 boot ROM 的处理器下载 flashloader）
8. 快速修复按钮

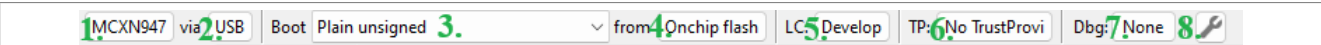


Figure 3. 工具栏

6.4 检查连接

可以使用 **main menu > Target > Connection** 命令或单击工具栏中的“connection”按钮，然后在连接配置对话框中选择 **Test connection**。这会在 ISP 模式下对处理器进行 ping 操作并检查是否可以建立连接。如果连接成功建立，对话框将显示所连接处理器的检测状态。

如果连接不起作用，请检查开发板是否配置为 ISP/SDP 模式并重置开发板。

6.5 生成 bootable image

如果您使用向导创建工作区，则构建页面上不应该出现任何错误。错误以红色显示，问题描述显示在工具提示中，因此如果有任何错误，请修复它们。

注意：忽略写入页面上的错误；在您构建镜像之前，会一直显示该错误。

单击 **Build image** 以生成一个 bootable image。进度显示在日志中。如果有任何问题，请阅读日志并修复。生成的文件作为该过程的一部分显示在按钮下方。最重要的列为第一个。它被称为 "build_image" 脚本，是在构建过程中执行的脚本。可以点击它并检查内容。

6.6 测试 bootable image

一旦构建了 bootable image，您就可以继续到 **Write image** 页面并将其写入引导内存。仔细检查确认没有报告错误，然后单击 **Write image** 按钮开始该过程。写入过程与构建过程类似。它将进行预检查，如果没有发现问题，它将生成写入脚本。如果写入脚本在处理器中做了任何不可逆的更改，GUI 将显示一个带有更改列表的确认对话框。之后，执行写入脚本，并在日志视图中列出详细信息。

应用程序写入完成后，验证其是否正确启动（从 ISP 切换到 RUN 模式并重置）。

6.7 接下来是什么

一旦可启动应用程序开始运行，就可以添加其他安全配置，例如：

- 使用签名或加密的镜像（image）进行安全启动
- 双镜像（image）启动
- 防回滚配置
- One-Time-Programmable（OTP）配置

建议每次更改后检查应用程序。如果应用程序无法启动，请恢复并找出导致问题的更改。该工具提供各种检查以防止无效配置。错误（红色）是阻塞问题，以防止将任何无效配置应用于处理器。警告（黄色）是不寻常/不推荐的设置，但它们是而非阻塞的。

一旦应用程序的安全配置最终确定并稳定，您就可以继续制造。该工具可以生成制造包 - 一个包含制造所需的所有文件的 ZIP 文件。在制造工厂中，导入包并应用（制造工具允许将其并行应用于多个开发板）。

6.8 特定处理器的工作流程

有一些特定于处理器的功能需要配置。这就是 [Secure Provisioning Tool User Guide](#) 中描述处理器特定工作流程的原因，“特定于处理器的工作流程”部分包含如何配置不同安全配置的分步过程。

7 参考资料

7.1 Release Notes

https://docs.mcuxpresso.nxp.com/secure/latest/release_notes.html

Secure Provisioning Tool Release Notes（文档 MCUXSPTRN）

7.2 User Guide

https://docs.mcuxpresso.nxp.com/secure/latest/01_introduction.html

Secure Provisioning Tool User Guide（文档 MCUXSPTUG）

7.3 NXP Secure Provisioning web

<https://nxp.com/sec>

7.4 Community, forum, knowledge base

<https://community.nxp.com/t5/MCUXpresso-Secure-Provisioning/tkb-p/mcux-secure-tool>

8 修订记录

Table 1. 修订记录

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